PAC2016EL

N-Ch and P-Ch Fast Switching MOSFET

V_{DS}=20V, I_D=0.6A, $RDS_{(ON)}$=360mΩ

V_{DS}=-20V, I_D=-0.4A, $RDS_{(ON)}$=620mΩ

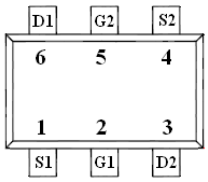
➢ General Description

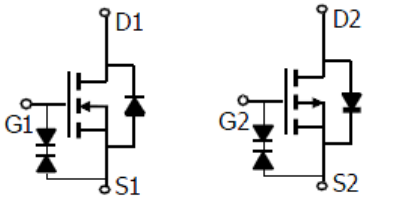
This PAC2016EL N&P Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent Rds(On) performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

➢ Feature

- ●Low Offset (Error) Voltage
- ●Low-Voltage Operation
- ●High-Speed Circuits
- ●ESD Protection
- ●Low Battery Voltage Operation
- ●SOT-563 package design

➢ SOT-563





n-channel **p-channel**

➢ Application

- ●Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- ●Battery Operated Systems
- ●Power Supply Converter Circuits
- ●Load/Power Switching Smart Phones, Pagers

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➢ N-Channel Absolute Maximum Ratings

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	20	V
Gate –Source Voltage		V_{GSS}	±12	V
Continuous Drain Current(T_J=150℃)	T_A=25℃	I_D	0.6	A
	T_A=70℃		0.4	
Pulsed Drain Current		I_{DM}	1.0	A
Continuous Source Current(Diode Conduction)		I_S	0.3	A
Power Dissipation	T_A=25℃	P_D	0.27	W
	T_A=70℃		0.16	
Operating Junction Temperature		T_J	-55/150	℃
Storage Temperature Range		T_{STG}	-55/150	℃

➢ N-Channel Electrical Characteristics (T_J=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=250uA	20			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250uA	0.4		1.0	
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±12V			±1	mA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=16V,V_{GS}=0V			1	uA
		V_{DS}=16V,V_{GS}=0V T_J=85℃			5	
On-State Drain Current	$I_{D(on)}$	V_{DS}≧5V,V_{GS}=4.5V	0.7			A
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=4.5V,I_D=0.6A		240	360	mΩ
		V_{GS}=2.5V,I_D=0.5A		300	420	
		V_{GS}=1.8V,I_D=0.4A		420	560	
Forward Transconductance	g_{FS}	V_{DS}=10V,I_D=0.4A		1		S
Diode Forward Voltage	V_{SD}	I_S=0.15A,V_{GS}=0V		0.8	1.2	V
Dynamic						
Input Capacitance	C_{iss}	V_{DS}=10V,V_{GS}=0V f=1MHz		70		pF
Output Capacitance	C_{oss}			20		
Reverse Transfer Capacitance	C_{rss}			8		
Total Gate Charge	Q_g	V_{DS}=10V,V_{GS}=4.5V I_D≡0.6A		1.06	1.38	nC
Gate-Source Charge	Q_{gs}			0.18		
Gate-Drain Charge	Q_{gd}			0.32		
Turn-On Time	$t_{d(on)}$	V_{DD}=10V,R_L=20Ω I_D≡0.5A,V_{GEN}=4.5V R_G=1Ω		18	26	ns
	t_r			20	28	
Turn-Off Time	$t_{d(off)}$			70	110	
	t_f			25	40	

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V_{DS}=-20V, I_D=-0.4A, $RDS_{(ON)}$=620mΩ

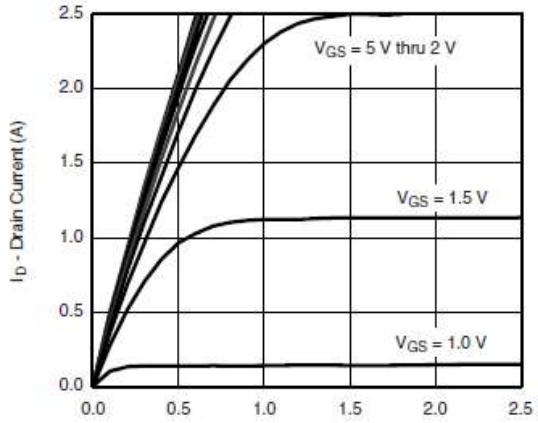
➢ P-Channel Absolute Maximum Ratings

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	-20	V
Gate –Source Voltage		V_{GSS}	±12	V
Continuous Drain Current(T_J=150℃)	T_A=25℃	I_D	-0.4	A
	T_A=70℃		-0.2	
Pulsed Drain Current		I_{DM}	-1.0	A
Continuous Source Current(Diode Conduction)		I_S	-0.3	A
Power Dissipation	T_A=25℃	P_D	0.27	W
	T_A=70℃		0.16	
Operating Junction Temperature		T_J	-55/150	℃
Storage Temperature Range		T_{STG}	-55/150	℃

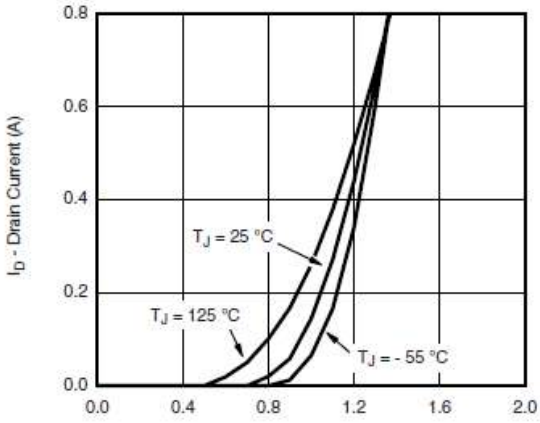
➢ P-Channel Electrical Characteristics (T_J=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=-250uA	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=-250uA	-0.4		-1.0	
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±12V			±1	mA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-20V,V_{GS}=0V			-5	uA
		V_{DS}=-20V,V_{GS}=0V T_J=85℃			-10	
On-State Drain Current	$I_{D(on)}$	V_{DS}≧5V,V_{GS}=4.5V	0.7			A
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=-4.5V,I_D=-0.4A		500	620	mΩ
		V_{GS}=-2.5V,I_D=-0.3A		700	860	
		V_{GS}=-1.8V,I_D=-0.2A		1000	1450	
Forward Transconductance	g_{FS}	V_{DS}=-10V,I_D=-0.4A		1		S
Diode Forward Voltage	V_{SD}	I_S=-0.15A,V_{GS}=0V		0.65	1.2	V
Dynamic						
Input Capacitance	C_{iss}	V_{DS}=-10V,V_{GS}=0V f=1MHz		70	100	pF
Output Capacitance	C_{oss}			20		
Reverse Transfer Capacitance	C_{rss}			10		
Total Gate Charge	Q_g	V_{DS}=-10V,V_{GS}=-4.5V I_D≡-0.25A		1.0	1.3	nC
Gate-Source Charge	Q_{gs}			0.1		
Gate-Drain Charge	Q_{gd}			0.3		
Turn-On Time	$t_{d(on)}$	V_{DD}=-10V,R_L=30Ω I_D≡-0.2A,V_{GEN}=-4.5V R_G=10Ω		10	15	ns
	t_r			10	15	
Turn-Off Time	$t_{d(off)}$			40	60	
	t_f			30	50	

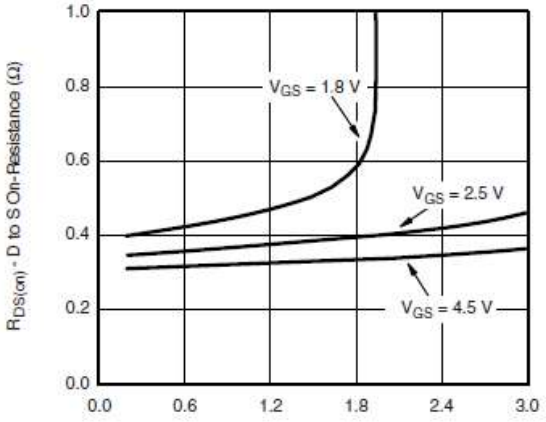
➢ N-Channel Typical Characteristics



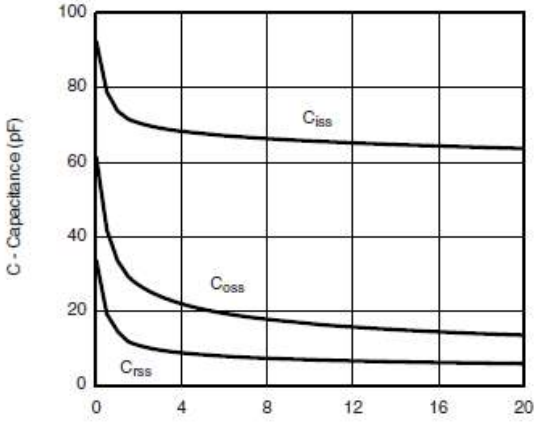
Output Characteristics



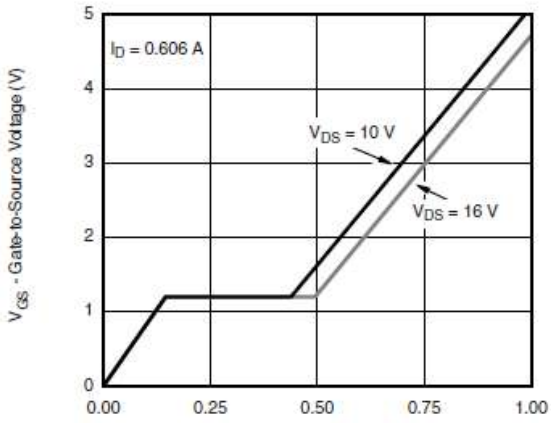
Transfer Characteristics



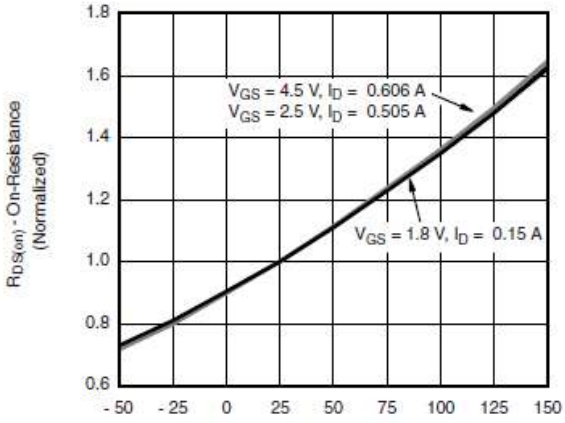
On-Resistance vs. Drain Current



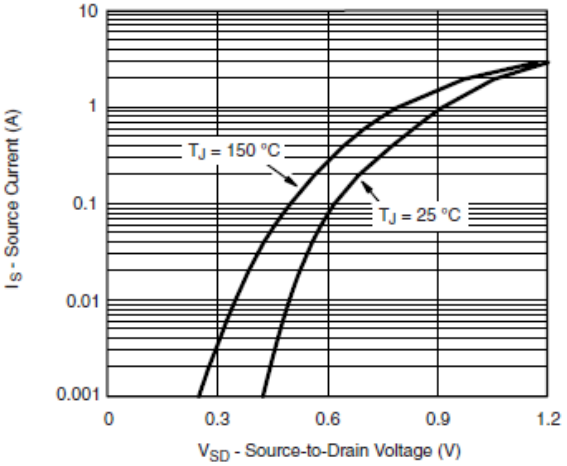
Capacitance



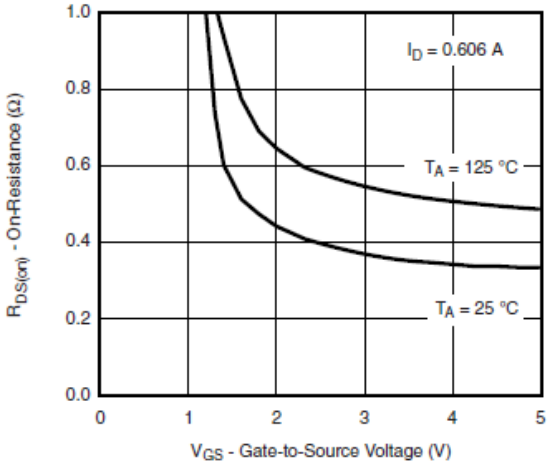
Gate Charge



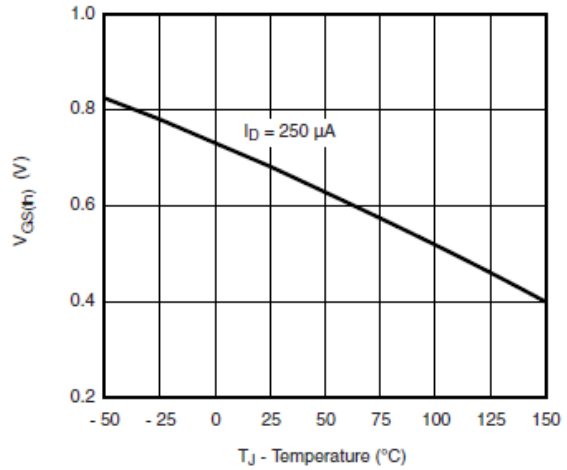
On-Resistance vs. Junction Temperature



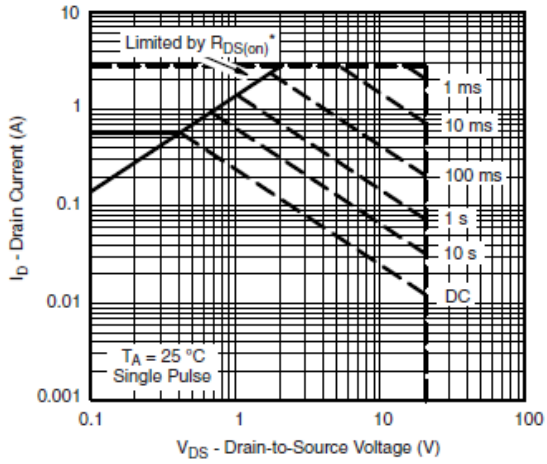
Source-Drain Diode Forward Voltage



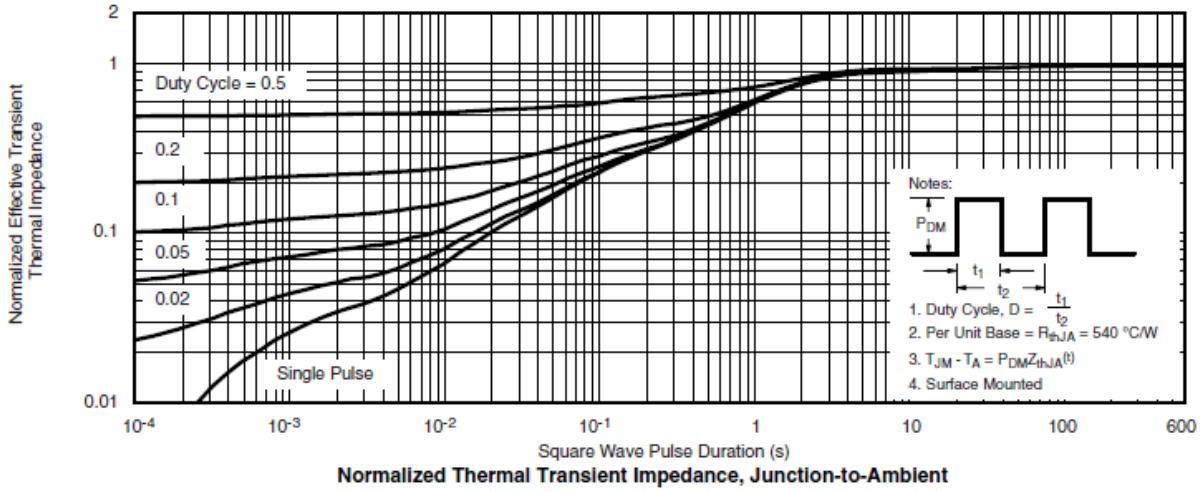
$R_{DS(on)}$ vs. V_{GS} vs Temperature



Threshold Voltage

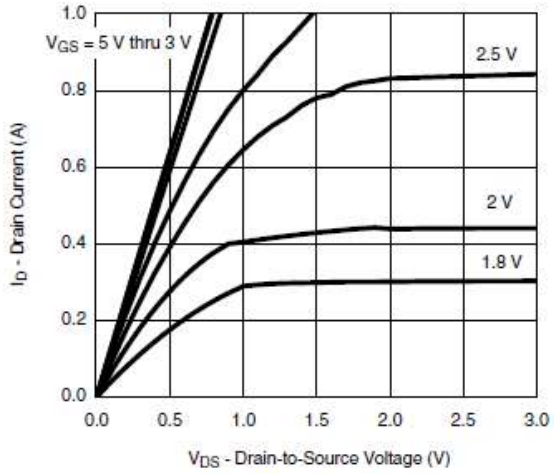


Safe Operating Area, Junction-to-Ambient

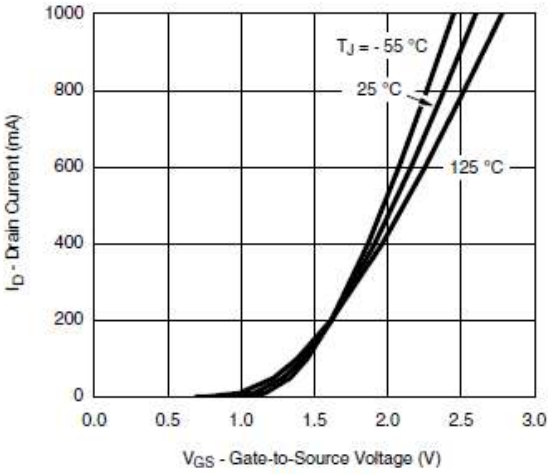


Normalized Thermal Transient Impedance, Junction-to-Ambient

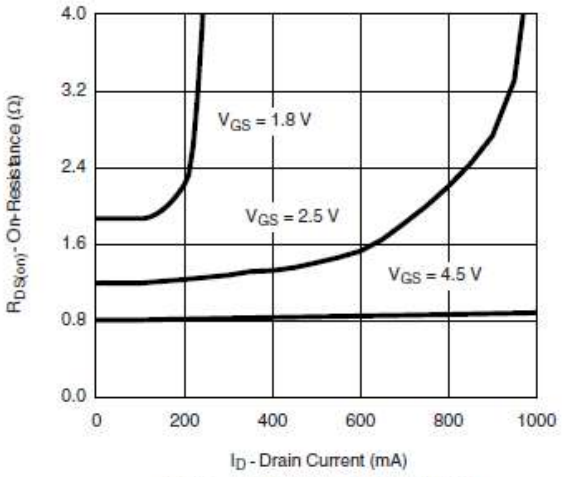
➢ P -Channel Typical Characteristics



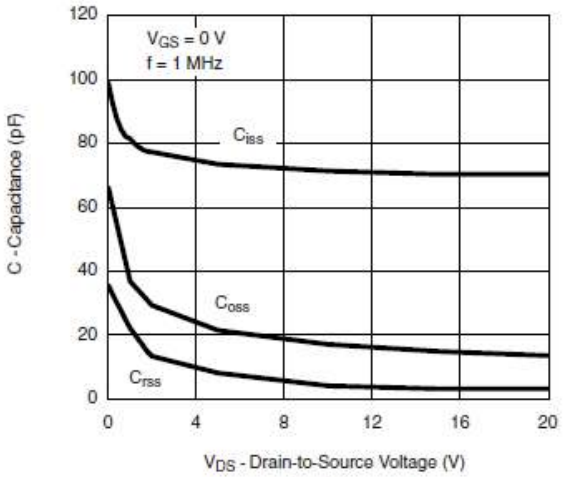
Output Characteristics



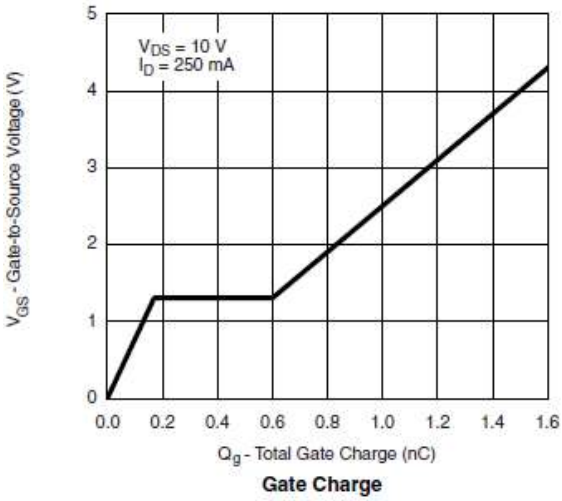
Transfer Characteristics



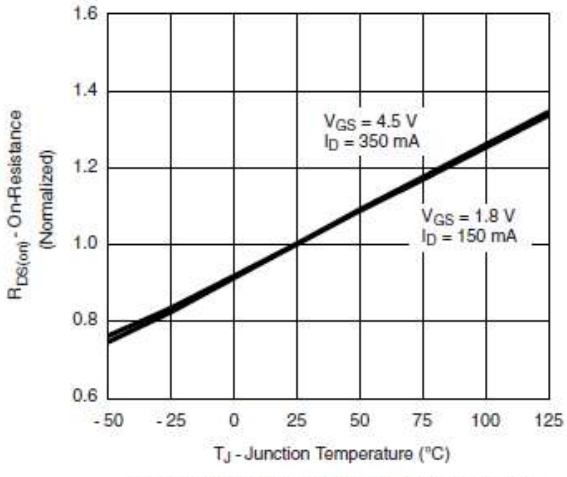
On-Resistance vs. Drain Current



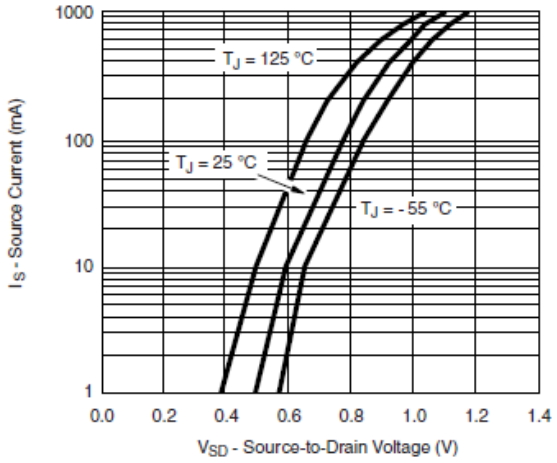
Capacitance



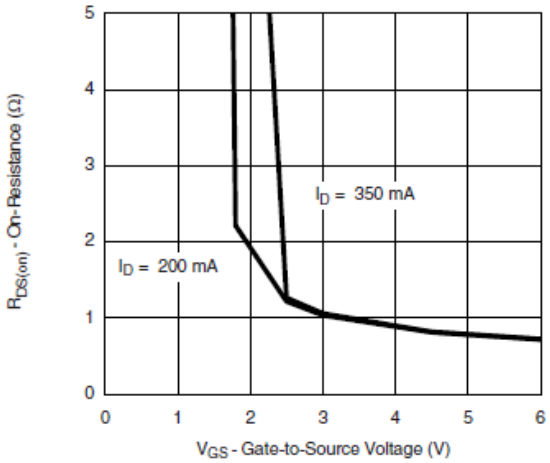
Gate Charge



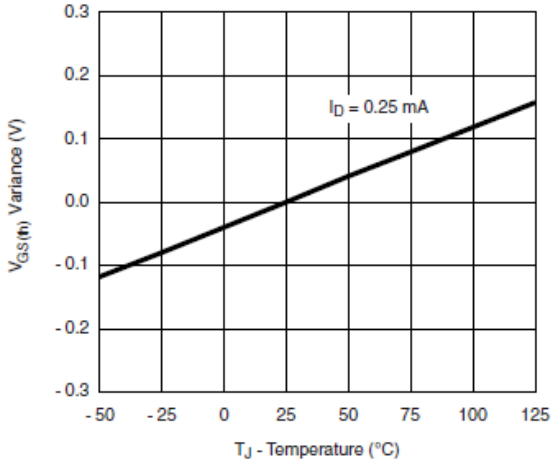
On-Resistance vs. Junction Temperature



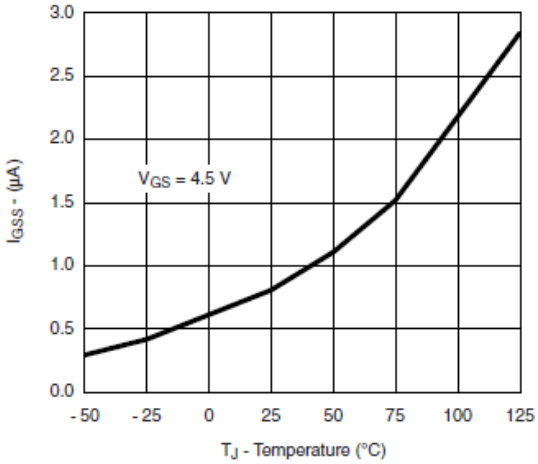
Source-Drain Diode Forward Voltage



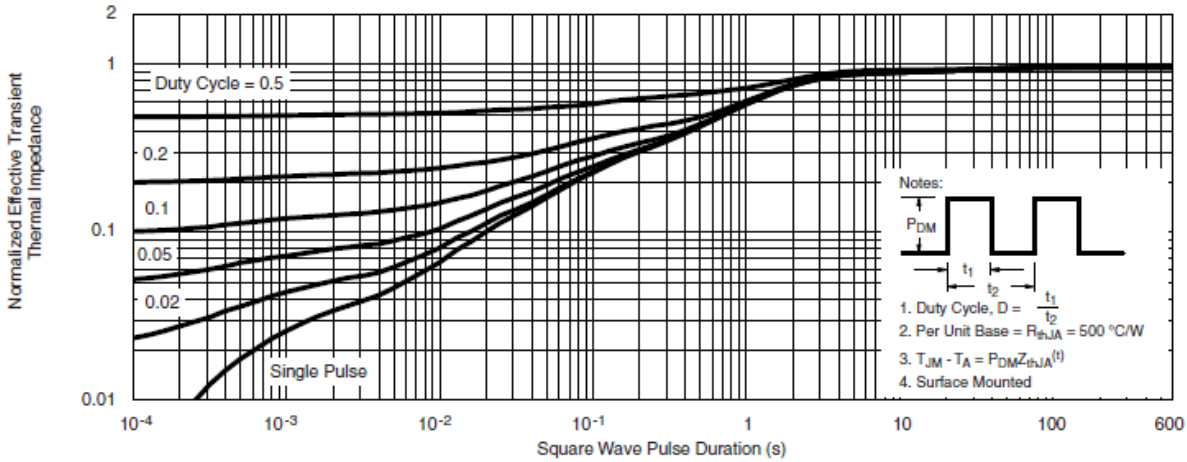
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage Variance vs. Temperature

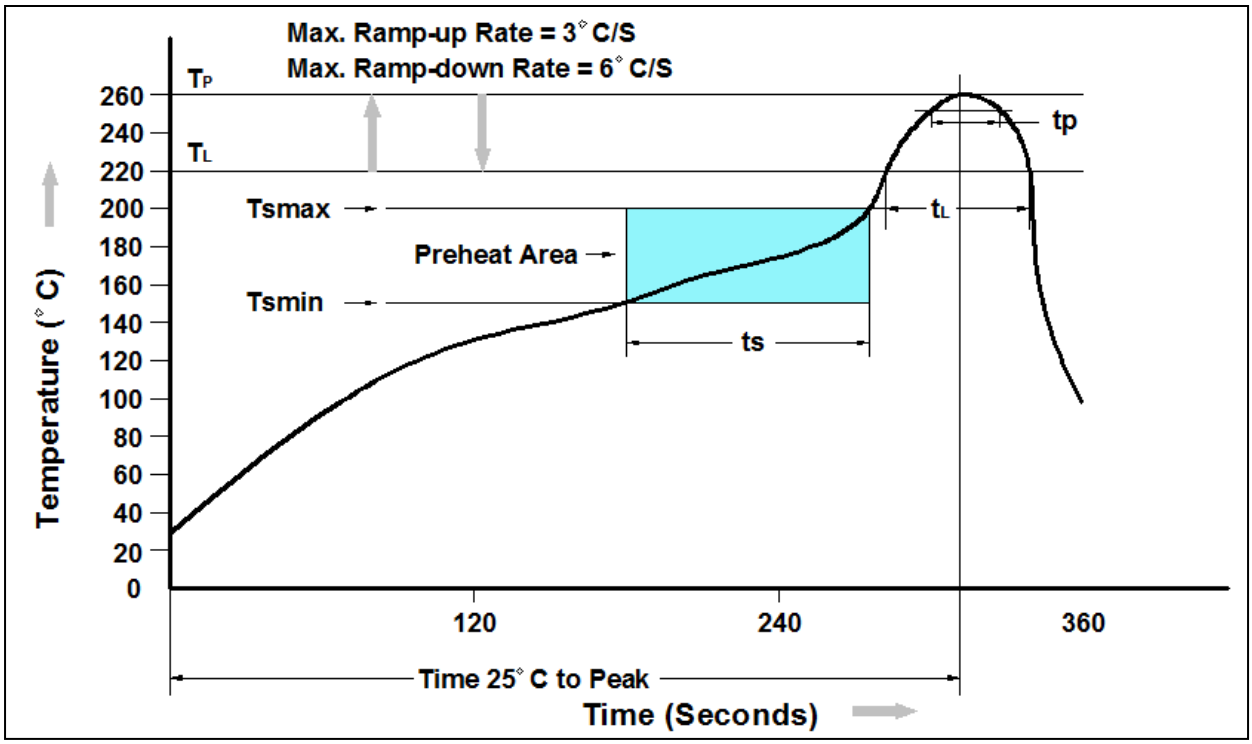


I_{GSS} vs. Temperature



Normalized Thermal Transient Impedance, Junction-to-Ambient

➢ Recommand IR Reflow Soldering Thermal Profile

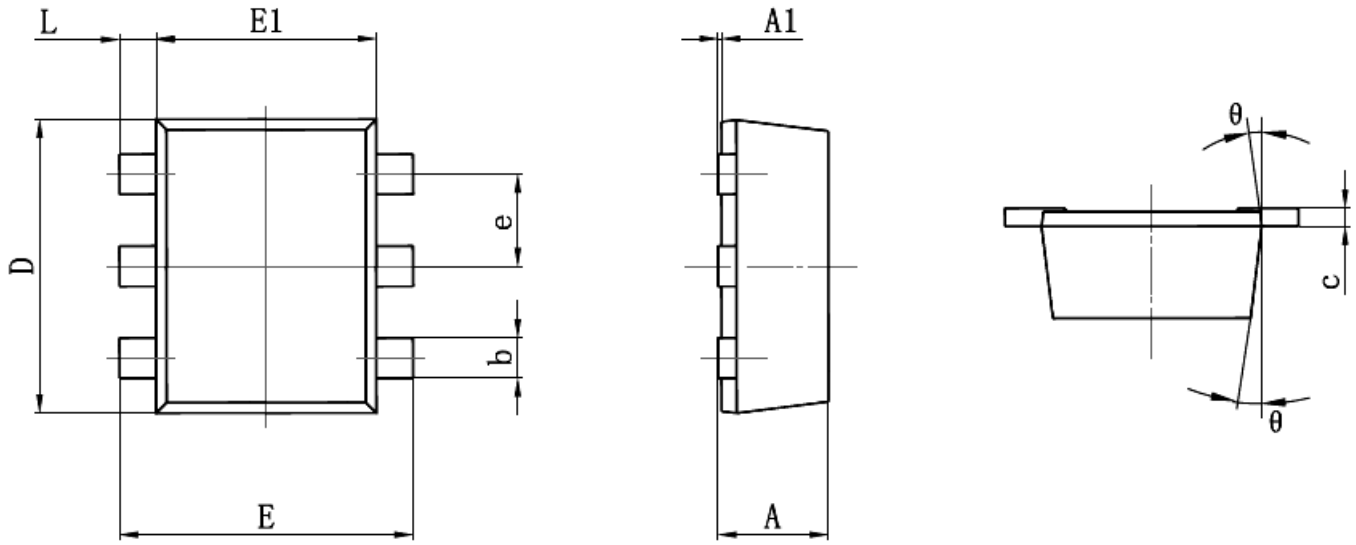


Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Average Ramp-up Rate (tL to tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

➢ Ordering Information

Part Number	Description	Quantity
PAC2016EL	SOT-563 Reel	3000 pcs

➢ Package Information (SOT-563)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.525	0.600	0.021	0.024
A1	0.000	0.050	0.000	0.002
e	0.450	0.550	0.018	0.022
c	0.090	0.160	0.004	0.006
D	1.500	1.700	0.059	0.067
b	0.170	0.270	0.007	0.011
E1	1.100	1.300	0.043	0.051
E	1.500	1.700	0.059	0.067
L	0.100	0.300	0.004	0.012
θ	7 °REF.		7 °REF.	

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- Though Paceleader make effort to improve product quality and reliability, Product can malfunction and fail due to their inherent electrical sensitivity and vulnerability to physical stress, it is the responsibility of the customer, when utilizing Paceleader products, to comply with the standards of safety in making a safe design for entire system and to avoid situation in which a malfunction or failure., In developing a new designs, customer should ensure that the device which shown in this documents are used within specified operating ranges.

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